

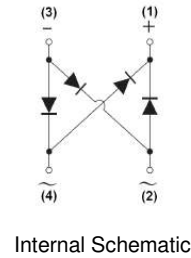
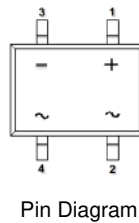
**1.5A SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER**

### Features and Benefits

- Glass Passivated Die Construction
- Low Forward Voltage Drop, High Current Capability
- Surge Overload Rating to 50A Peak
- Designed for Surface Mount Applications
- UL Listed Under Recognized Component Index, File Number E525394
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](mailto:contact@diodes.com) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

### Mechanical Data

- Package: DF-S
- Package Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Tin. Solder Plated Leads, Solderable per MIL-STD-202, Method 208 (E3)
- Polarity: As Marked on Case
- Marking: Type Number
- Weight: 0.38 grams (Approximate)

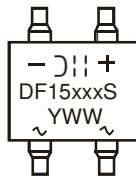


### Ordering Information (Note 3)

Part Number	Package	Packing	
		Qty.	Carrier
DF15xxxS-T	DF-S	1500	Tape & Reel
DF15xxxS	DF-S	50	Per Tube

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

### Marking Information



DII = Manufacturer's Code Marking  
 DF15xxxS = Product Type Marking Code  
           ex: DF1510S  
 YWW = Date Code Marking  
 Y = Last Digit of Year (ex: 2 for 2022)  
 WW = Week Code (01 to 53)

## Maximum Ratings and Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	DF 15005S	DF 1501S	DF 1502S	DF 1504S	DF 1506S	DF 1508S	DF 1510S	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>								
Working Peak Reverse Voltage	V <sub>RWM</sub>	50	100	200	400	600	800	1000	V
DC Blocking Voltage	V <sub>R</sub>								
RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	70	140	280	420	580	700	V
Average Forward Rectified Current @ T <sub>A</sub> = +40°C	I <sub>O</sub>	1.5							A
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	50							A
Forward Voltage (Per Element) @ I <sub>F</sub> = 1.5A	V <sub>FM</sub>	1.1							V
Peak Reverse Current at Rated @ T <sub>A</sub> = +25°C	I <sub>RM</sub>	10							μA
DC Blocking Voltage (Per Element) @ T <sub>A</sub> = +125°C		500							
I <sup>2</sup> t Rating for Fusing (t < 8.3ms)	I <sup>2</sup> t	10.4							A <sup>2</sup> s
Typical Total Capacitance per Element (Note 4)	C <sub>T</sub>	25							pF
Typical Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θJA</sub>	40							°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150							°C

Notes: 4. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.  
5. Thermal resistance, junction to ambient, measured on PC board with 5.0mm<sup>2</sup> (0.03mm thick) land areas.

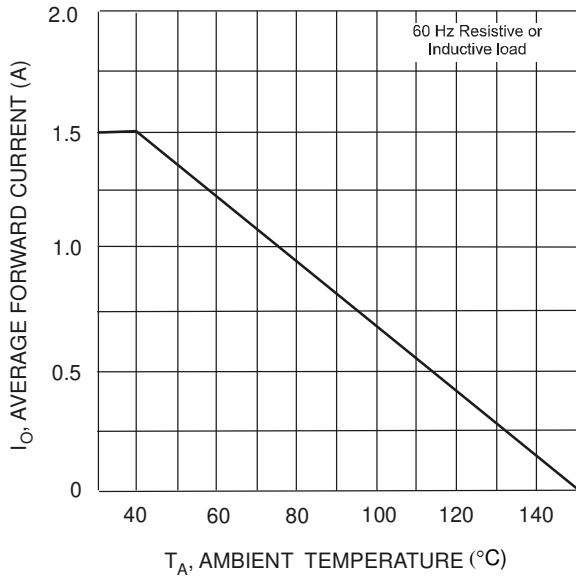


Fig. 1 Output Current Derating Curve

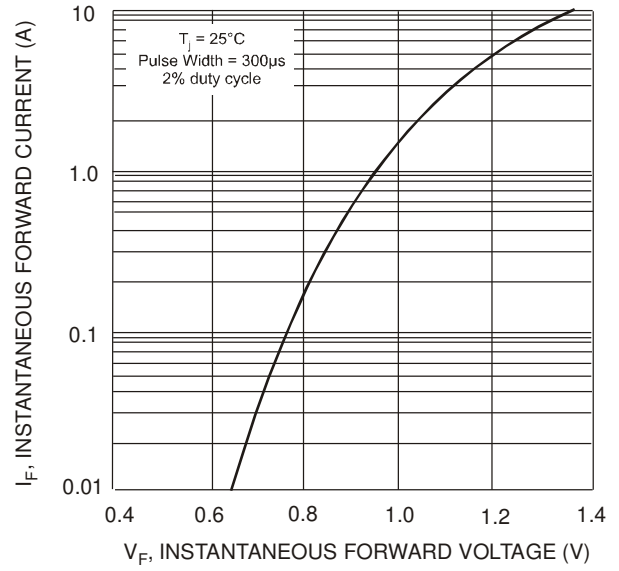


Fig. 2 Typical Forward Characteristics (per element)

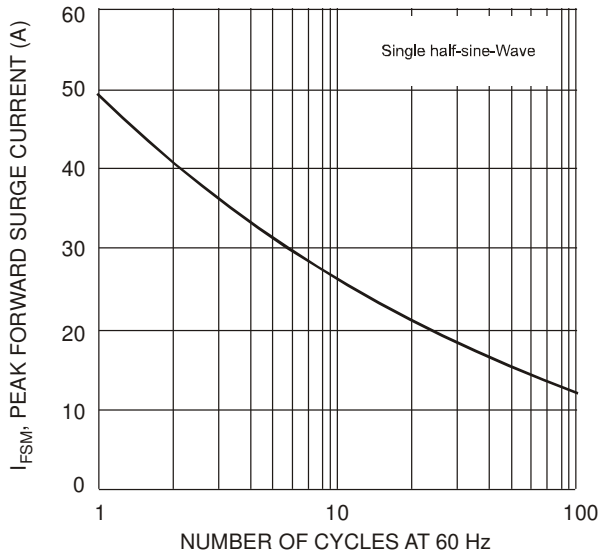


Fig. 3 Max Non-Repetitive Peak Forward Surge Current

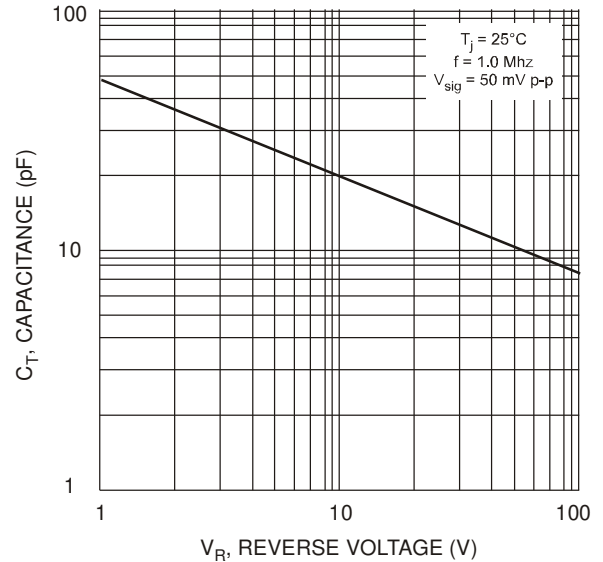


Fig. 4 Typical Total Capacitance (per element)

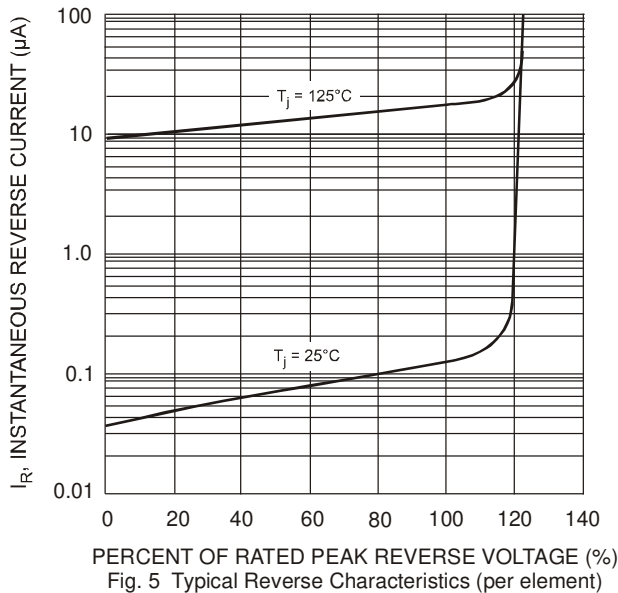
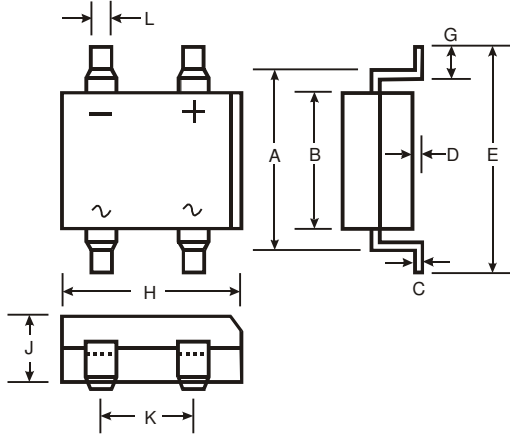


Fig. 5 Typical Reverse Characteristics (per element)

**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**DF-S**

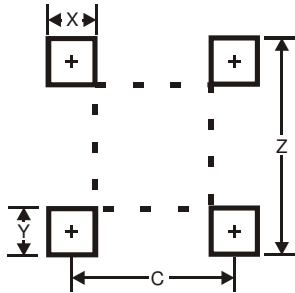


DF-S		
Dim	Min	Max
A	7.40	7.90
B	6.20	6.50
C	0.22	0.30
D	0.076	0.33
E	-	10.40
G	1.02	1.53
H	8.13	8.51
J	2.40	2.60
K	5.00	5.20
L	1.00	1.20
<b>All Dimensions in mm</b>		

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**DF-S**



Dimensions	Value (in mm)
Z	10.26
X	1.2
Y	1.52
C	5.2

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